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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Paul A. Farrar

) Group Art Unit 2815

Appl. No. : 09/909, 181

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Filed : July 19, 2001

) April 6, 2002
(Date)

For : METHOD OF USING
FOAMED INSULATORS IN
THREE DIMENSIONAL
MULTICHIP STRUCTURES

) Michael H. Trenholm, Reg. No. 37,743

Examiner : Chris C. Chu

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Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

In response to the Restriction Requirement mailed March 15, 2002, the Applicant hereby elects Claim Group I (i.e., Claims 1-26). By this paper, Applicant hereby cancels Claims 27-32, without prejudice. The Applicant believes that the application is now in condition for examination on the merits and requests the prompt examination of the same. Should there be any impediment to the prompt examination of this application that could be resolved by a telephone conference, the Examiner is respectfully requested to call the undersigned at the number shown below.

Appl. No. : 909, 181
Filed : July 19, 2001

Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

By: _____

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